Infineon technologies

# Step Down Voltage-Regulator with Reset

TLE 6365

Datasheet

1   Overview

1.1   Features

- Step down converter
- Supply Over- and Under-Voltage-Lockout
- Low Output voltage tolerance
- Output Overvoltage Lockout
- Output Under-Voltage-Reset with delay
- Overtemperature Shutdown
- Wide Ambient operation range -40°C to 125°C
- Wide Supply voltage operation range
- Very low current consumption
- Very small P-DSO-8 SMD package
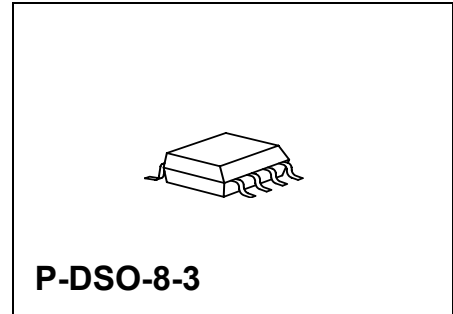
P-DSO-8-3

Type	Ordering Code	Package
TLE 6365 G	**Q67006-A9515**	**P-DSO-8-3**

Functional description

General

The **TLE 6365 G** is a power supply circuit especially designed for automotive applications.

The device is based on Infineon's power technology SPT® which allows bipolar and CMOS control circuitry to be integrated with DMOS power devices on the same monolithic circuitry.

The **TLE 6365 G** contains a buck converter and a power on reset feature to start up the system.

The very small **P-DSO-8-3** SMD package meets the application requierements.

It delivers a precise 5V fully short circuit protected output voltage.

Furthermore, the build-in features like under- and overvoltage lockout for supply- and output-voltage and the overtemperature shutdown feature increase the reliability of the **TLE 6365 G** supply system.

1.2 Pin Definitions and Functions

| Pin No	Symbol	Function
1	R	**Reference Input**; an external resistor from this pin to GND determines the reference current and so the oscillator / switching frequency
2	RO	**Reset Output**; open drain output from reset comparator with an internal pull up resistor
3	BUC	**Buck-Converter Compensation Input**; output of internal error amplifier; for loop-compensation and therefore stability connect an external R-C-series combination to GND.
4	GND	**Ground**; analog signal ground
5	V_{CC}	**Output Voltage Input;** feedback input (with integrated resistor devider) and logic supply input; external blocking capacitor necessary
7	BUO	**Buck Converter Output**; source of the integrated power-DMOS
6	BDS	**Buck Driver Supply Input**; voltage to drive the buck converter powerstage
8	V_S	**Supply Voltage Input**; buck converter input voltage; external blocking capacitor necessary.

Pin Configuration

P-DSO-8-3
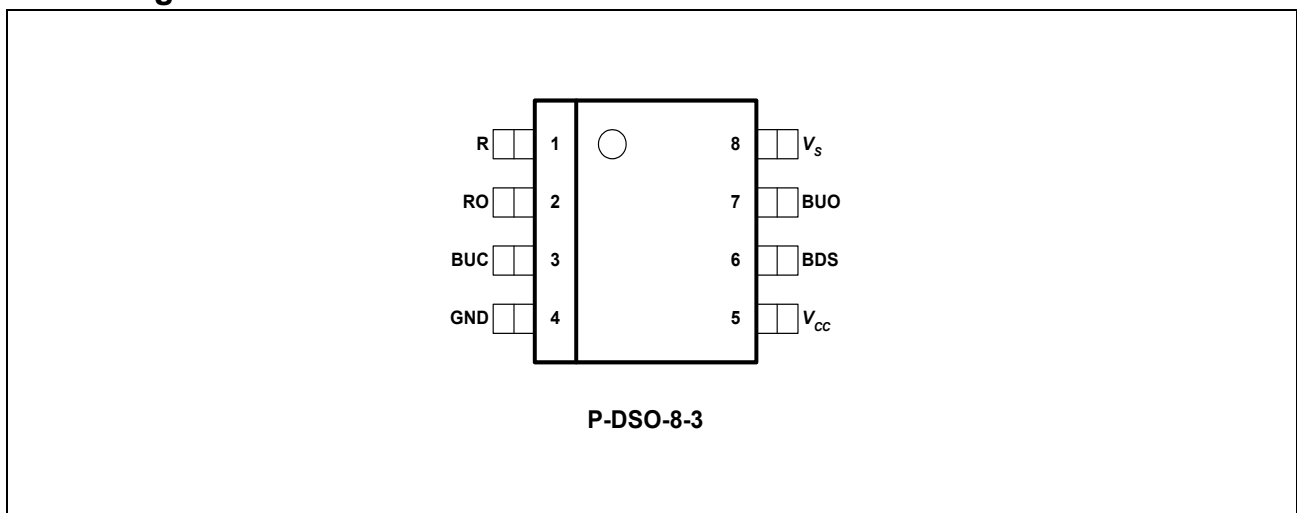
Figure 1   Pin Configuration (top view)

1.3 Block Diagram
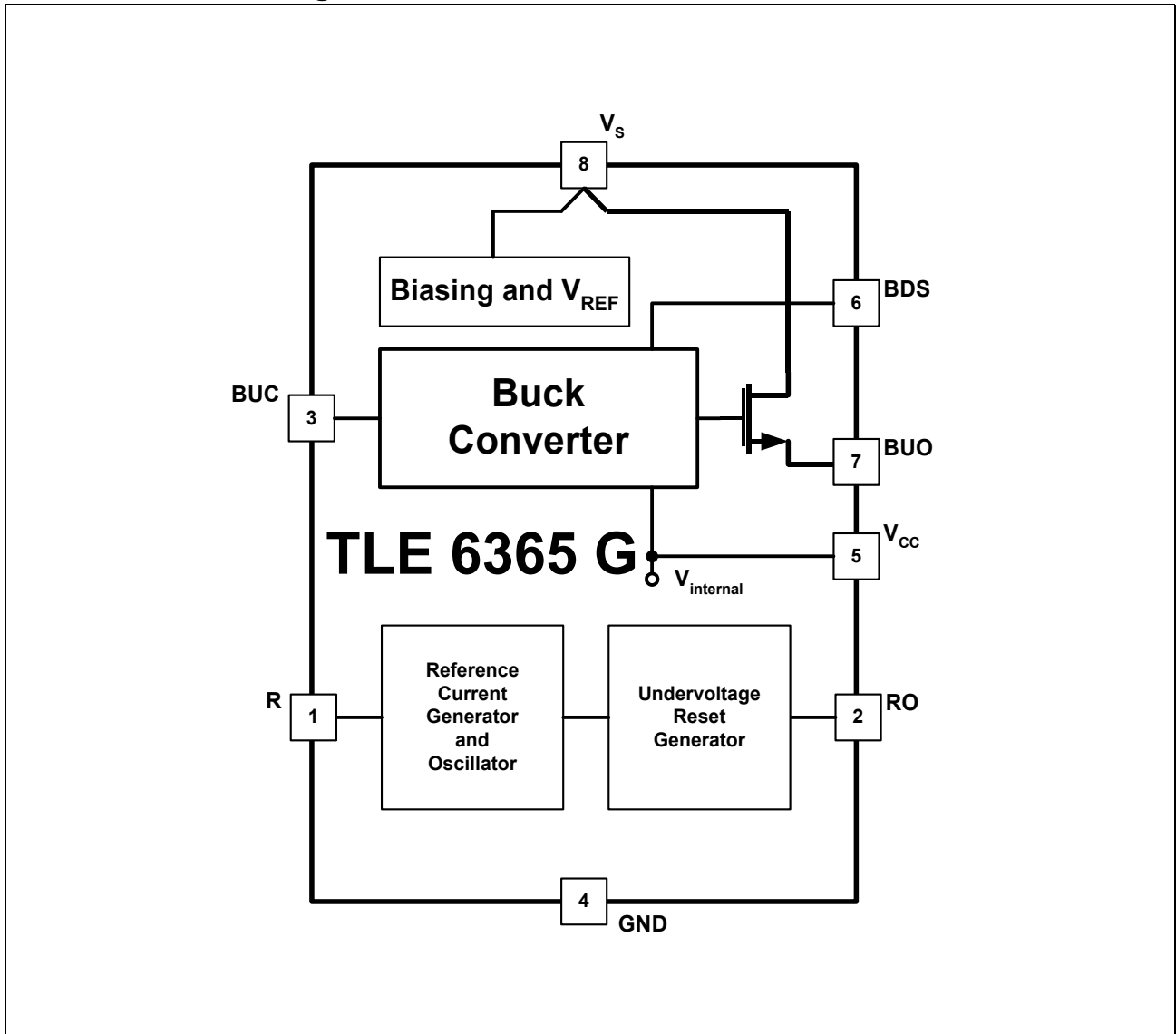
Figure 2   Block Diagram

1.4 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		

Voltages

Parameter	Symbol	Limit Values		Unit	Remarks
Supply voltage	V_S	– 0.3	46	V	
Buck output voltage	V_{BUO}	– 1	46	V	
Buck driver supply voltage	V_{BDS}	– 0.3	55	V	
Buck compensation input voltage	V_{BUC}	– 0.3	6.8	V	
Logic supply voltage	V_{CC}	– 0.3	6.8	V	
Reset output voltage	V_{RO}	– 0.3	6.8	V	
Current reference voltage	V_R	– 0.3	6.8	V	

ESD-Protection (Human Body Model; R=1,5kΩ; C=100pF)

Parameter	Symbol	Limit Values		Unit	Remarks
all pins to GND	V_{HBM}	–2	2	kV	

Temperatures

Parameter	Symbol	Limit Values		Unit	Remarks
Junction temperature	T_j	– 40	150	°C	–
Storage temperature	T_{stg}	– 50	150	°C	–

Note: Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

1.5 Operating Range

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Supply voltage	V_S	– 0.3	40	V	
Supply voltage	V_S	5	35	V	V_S increasing
Supply voltage	V_S	4.5	36	V	V_S decreasing
Supply voltage	V_S	– 0.3	4.5	V	Buck-Converter OFF
Buck output voltage	V_{BUO}	– 0.6	40	V	
Buck driver supply voltage	V_{BDS}	– 0.3	50	V	
Buck compensation input voltage	V_{BUC}	0	3.0	V	
Logic supply voltage	V_{CC}	4.0	6.2	V	
Reset output voltage	V_{RO}	– 0.3	V_{CC} +0.3	V	
Current reference voltage	V_{CREF}	0	1.23	V	
Junction temperature	T_j	– 40	150	°C	

Thermal Resistance

Junction ambient	$R_{thj\text{-}a}$		180	K/W	–

1.6 Electrical Characteristics

8V< V_S < 35V; 4.75V< V_{CC} <5.25V; - 40°C< T_j <150°C; R_R=47kΩ;

all voltages with respect to ground; positive current defined flowing into the pin; unless otherwise specified

No.	Parameter	Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
1.6.1	**Current Consumption**						
1.6.1.1	Current consumption; see applicatiopn circuit	I_S		1.5	4	mA	I_{CC}=0mA
1.6.1.2	Current consumption; see applicatiopn circuit	I_S		5	10	mA	I_{CC}=400mA
1.6.2	**Under- and Over-Voltage Lockout at V_S**						
1.6.2.1	UV ON voltage; buck conv. ON	V_{SUVON}	4.0	4.5	5.0	V	V_S increasing;
1.6.2.2	UV OFF voltage; buck conv. OFF	V_{SUVOFF}	3.5	4.0	4.5	V	V_S decreasing
1.6.2.3	UV Hysteresis voltage	V_{SUVHY}	0.2	0.5	1.0	V	HY = ON - OFF
1.6.2.4	OV OFF voltage; buck conv. OFF	V_{SOVOFF}	34	37	40	V	V_S increasing
1.6.2.5	OV ON voltage; buck conv. ON	V_{SOVON}	30	33	36	V	V_S decreasing
1.6.2.6	OV Hysteresis voltage	V_{SUVHY}	1.5	4	10	V	HY = OFF - ON
1.6.3	**Over-Voltage Lockout at V_{CC}**						
1.6.3.1	OV OFF voltage; buck conv. OFF	$V_{CCOVOFF}$	5.5	6.0	6.5	V	V_{CC} increasing
1.6.3.2	OV ON voltage; buck conv. ON	V_{CCOVON}	5.25	5.75	6.25	V	V_{CC} decreasing
1.6.3.3	OV Hysteresis voltage	V_{CCOVHY}	0.10	0.25	0.50	V	HY = OFF - ON

1.6 Electrical Characteristics (cont'd)

$8V < V_S < 35V$; $4.75V < V_{CC} < 5.25V$; $-40°C < T_j < 150°C$; $R_R = 47k\Omega$;

all voltages with respect to ground; positive current defined flowing into the pin; unless otherwise specified

No.	Parameter	Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
1.6.4	**Buck-Converter; BUO, BDS, BUC and V_{CC}**						
1.6.4.1	Logic supply voltage	V_{CC}	4.9		5.1	V	1mA < I_{CC}< 400mA; see. appl. circuit
1.6.4.2	Efficiency; see. appl. circuit	η		85		%	I_{CC} = 400mA; V_S = 14V
1.6.4.3	Power-Stage ON resistance	R_{BUON}		0.38	0.5	Ω	T_j=25°C; I_{BUO}= 0.6A
1.6.4.4	Power-Stage ON resistance	R_{BUON}			1.0	Ω	I_{BUO}= 0.6A
1.6.4.5	Buck overcurrent threshold	I_{BUOC}	0.7	0.9	1.2	A	
1.6.4.6	Input current on pin V_{CC}	I_{CC}			500	µA	V_{CC}=5V
1.6.4.7	Buck Gate supply voltage; $V_{BGS}=V_S - V_{BDS}$	V_{BGS}	5	7.2	10	V	
1.6.5	**Reference Input ; R (Oscillator; Timebase for Buck-Converter and Reset)**						
1.6.5.1	Voltage on pin R	V_R		1.4		V	R_R = 100kΩ
1.6.5.2	Oscillator frequency	f_{OSC}	85	95	105	kHz	T_j = 25°C
1.6.5.3	Oscillator frequency	f_{OSC}	75		115	kHz	
1.6.5.4	Cycle time for reset timing	t_{CYL}		1		ms	t_{CYL} = 100 / f_{OSC}

1.6 Electrical Characteristics (cont'd)

$8V < V_S < 35V$; $4.75V < V_{CC} < 5.25V$; $-40°C < T_j < 150°C$; $R_R = 47k\Omega$;

all voltages with respect to ground; positive current defined flowing into the pin; unless otherwise specified

No.	Parameter	Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
1.6.6	**Reset Generator; RO**						
1.6.6.1	Reset threshold; V_{CC} decreasing	V_{RT}	4.50	4.65	4.75	V	V_{RO} H to L or L to H transition; V_{RO} remains low down to $V_{CC} > 1V$
1.6.6.2	Reset low voltage	V_{ROL}	-	0.2	0.4	V	$I_{ROL} = 1mA$; $2.5V < V_{CC} < V_{RT}$
1.6.6.3	Reset low voltage	V_{ROL}	-	0.2	0.4	V	$I_{ROL} = 0.2mA$; $1V < V_{CC} < V_{RT}$
1.6.6.4	Reset high voltage	V_{ROH}	V_{CC} -0.1		V_{CC} +0.1	V	$I_{ROH} = 0mA$
1.6.6.5	Reset pull up curent	I_{RO}		240		µA	$0V < V_{RO} < 4V$
1.6.6.6	Reset Reaction time	t_{RR}	10	40	90	µs	$V_{CC} < V_{RT}$
1.6.6.7	Power-up reset delay time	t_{RD}		128		t_{CYL}	$V_{CC} \geq 4.8 V$
1.6.7	**Thermal Shutdown (Boost and Buck-Converter OFF)**						
1.6.7.1	Thermal shutdown junction temperature	T_{jSD}	150	175	200	°C	
1.6.7.2	Thermal switch-on junction temperature	T_{jSO}	120		170	°C	
1.6.7.3	Temperature hysteresis	ΔT		30		K	

2 Circuit Description

Below some important sections of the **TLE 6365** are described in more detail.

Power On Reset

In order to avoid any system failure, a sequence of several conditions has to be passed. In case of V_{CC} power down ($V_{CC} < V_{RT}$ for $t > t_{RR}$) a logic LOW signal is generated at the pin RO to reset an external microcontroller. When the level of V_{CC} reaches the reset threshold V_{RT}, the signal at RO remains LOW for the Power-up reset delay time t_{RD} before switching to HIGH. If V_{CC} drops below the reset threshold V_{RT} for a time extending the reset reaction time t_{RR}, the reset circuit is activated and a power down sequence of period t_{RD} is initiated. The reset reaction time t_{RR} avoids wrong triggering caused by short "glitches" on the V_{CC}-line.
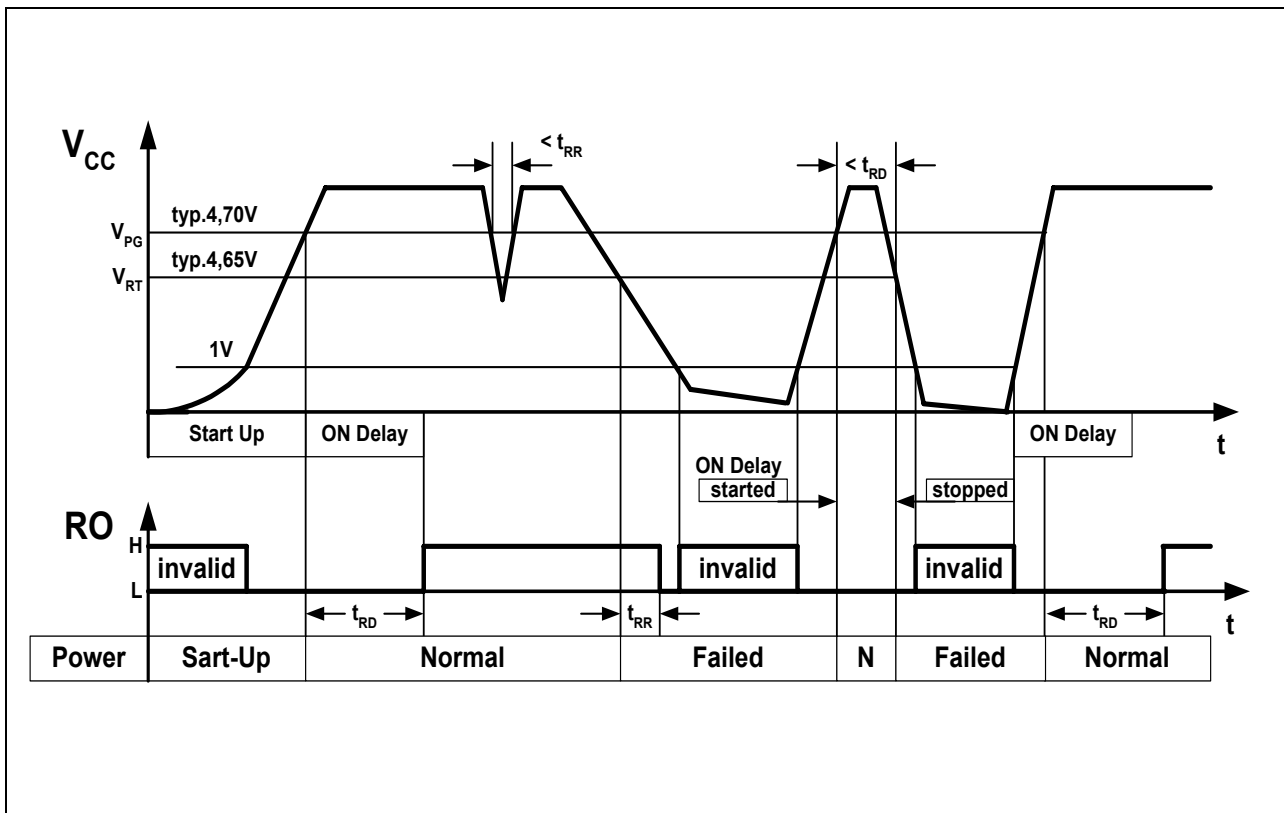
Figure 3   Reset Function

Buck Converter

A stabilized logic supply voltage (typ. 5 V) for general purpose is realized in the system by a buck converter. An external buck-inductance L_{BU} is PWM switched by a high side DMOS power transistor with the programmed frequency (pin R).

The buck converter uses the temperature compensated bandgap reference voltage (typ. 2.8 V) for its regulation loop.
This reference voltage is connected to the non-inverting input of the error amplifier and an internal voltage divider supplies the inverting input. Therefore the output voltage V_{CC} is fixed due to the internal resistor ratio to typ. 5.0 V.
The output of the error amplifier goes to the inverting input of the PWM comparator as well as to the buck compensation output BUC.
When the error amplifier output voltage exceeds the sawtooth voltage the output power MOS-transistor is switched on. So the duration of the output transistor conduction phase depends on the V_{CC} level. A logic signal PWM with variable pulse width is generated.
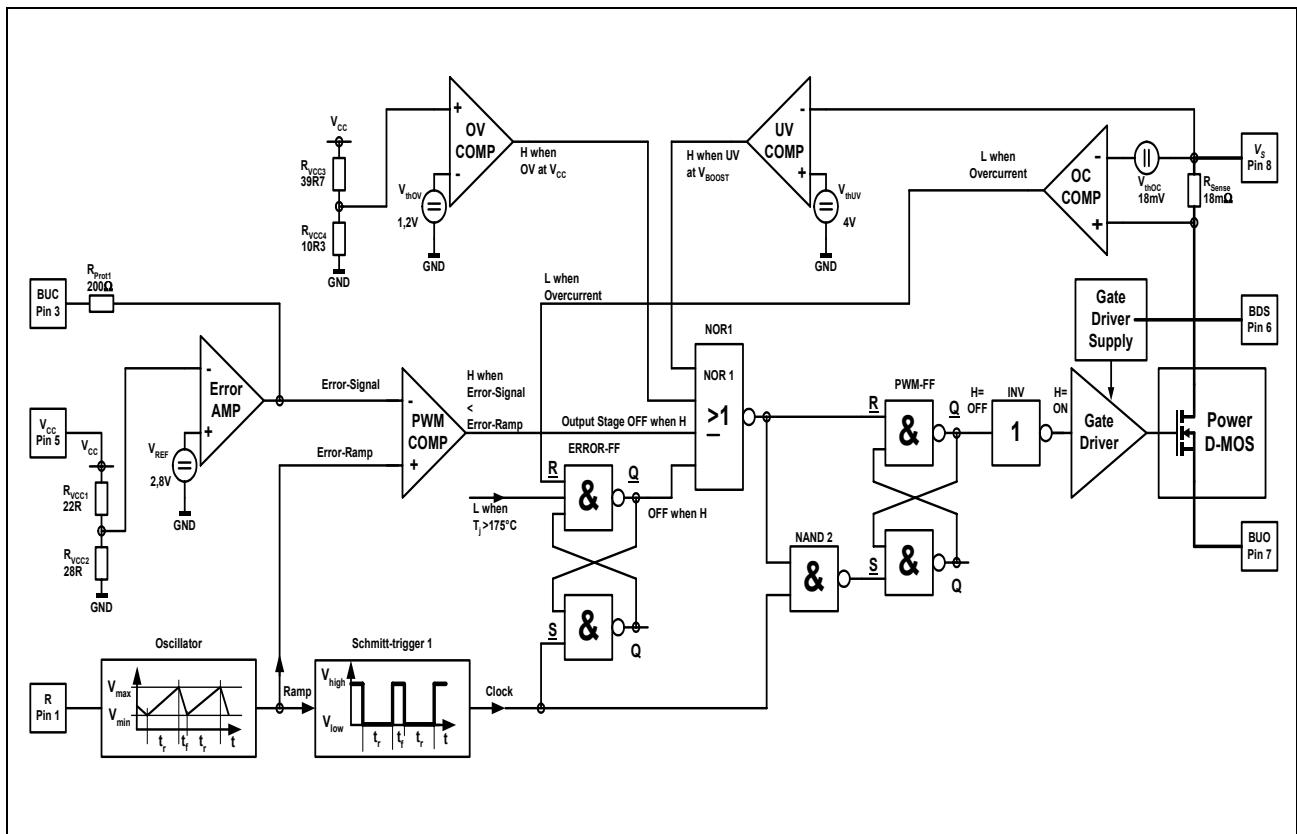
Figure 4   Buck Converter Block Diagram

External loop compensation is required for converter stability, and is formed by connecting a compensation resistor-capacitor series-network (R_{BUC}, C_{BUC}) between pin BUC and GND.

In the case of overload or short-circuit at V_{CC} (the output current exceeds the buck overcurrent threshold I_{BUOC}) the DMOS output transistor is switched off by the overcurrent comparator immediately.

In order to protect the V_{CC} input as well as the external load against catastrophic failures, an overvoltage protection is provided which switches off the output transistor as soon as the voltage at pin V_{CC} exceeds the internal fixed overvoltage threshold $V_{CCOVOFF}$ = typ. 6.0 V.

Also a battery undervoltage protection is implemented in the **TLE 6365** to avoid wrong operation of the following supplied devices, the typical threshold when decreasing the battery voltage is at V_{SUVOFF} = typ. 4.0 V.
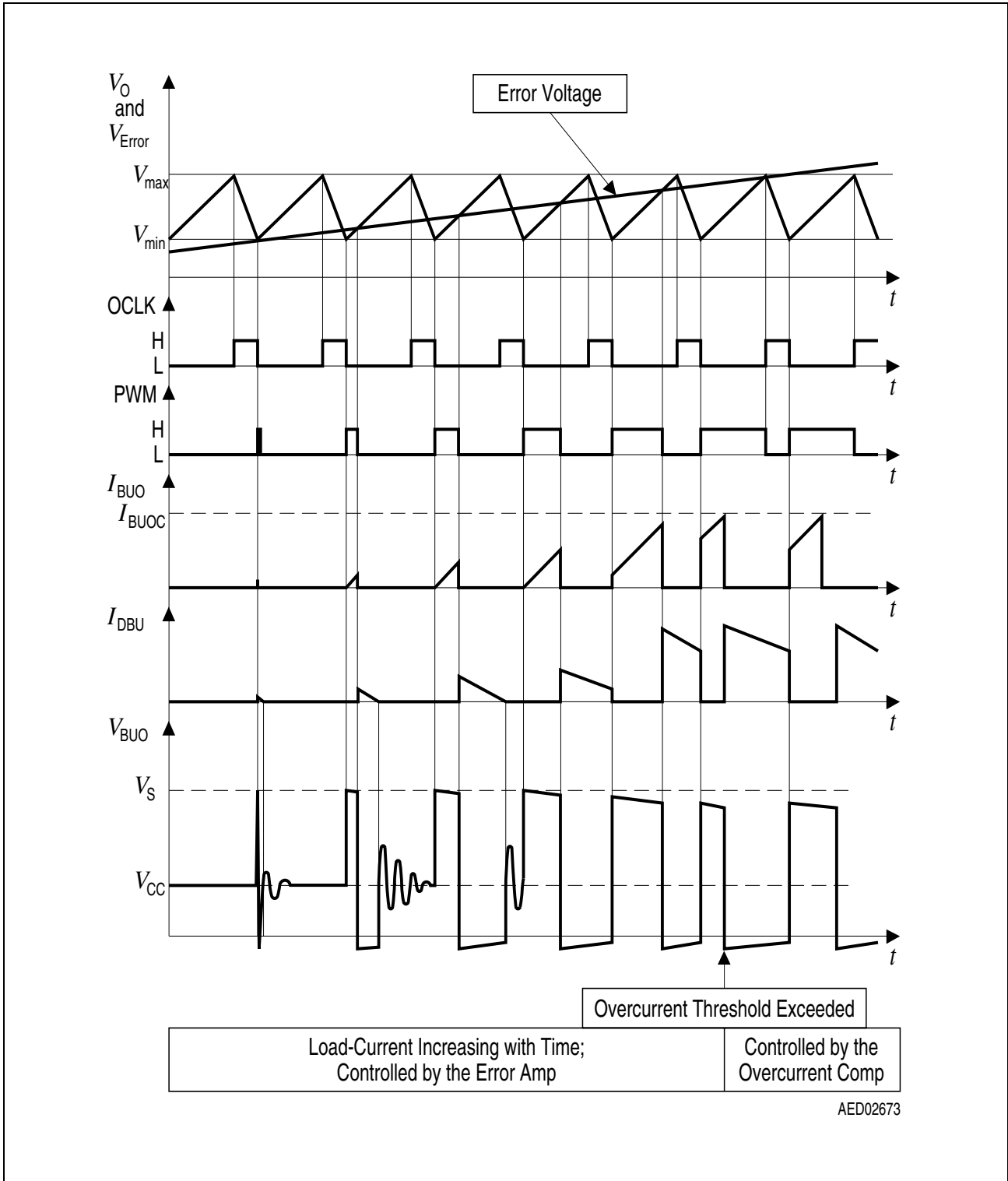
Figure 5 **Most Important Waveforms of the Buck Converter Circuit**

3 Application circui

t

Device	Type	Supplier	Remarks
D_1	BAW78C	Infineon	200V; 1A; SOT89
D_{BU}	SS14	-	Schottky; 100V; 1A
L_{BU}	B82476-A1224-M	Epcos	220µH; 0.8A; 0.53Ω
L_{BU}	DO3316P-224	Coilcraft	220µH; 0.8A; 0.61Ω
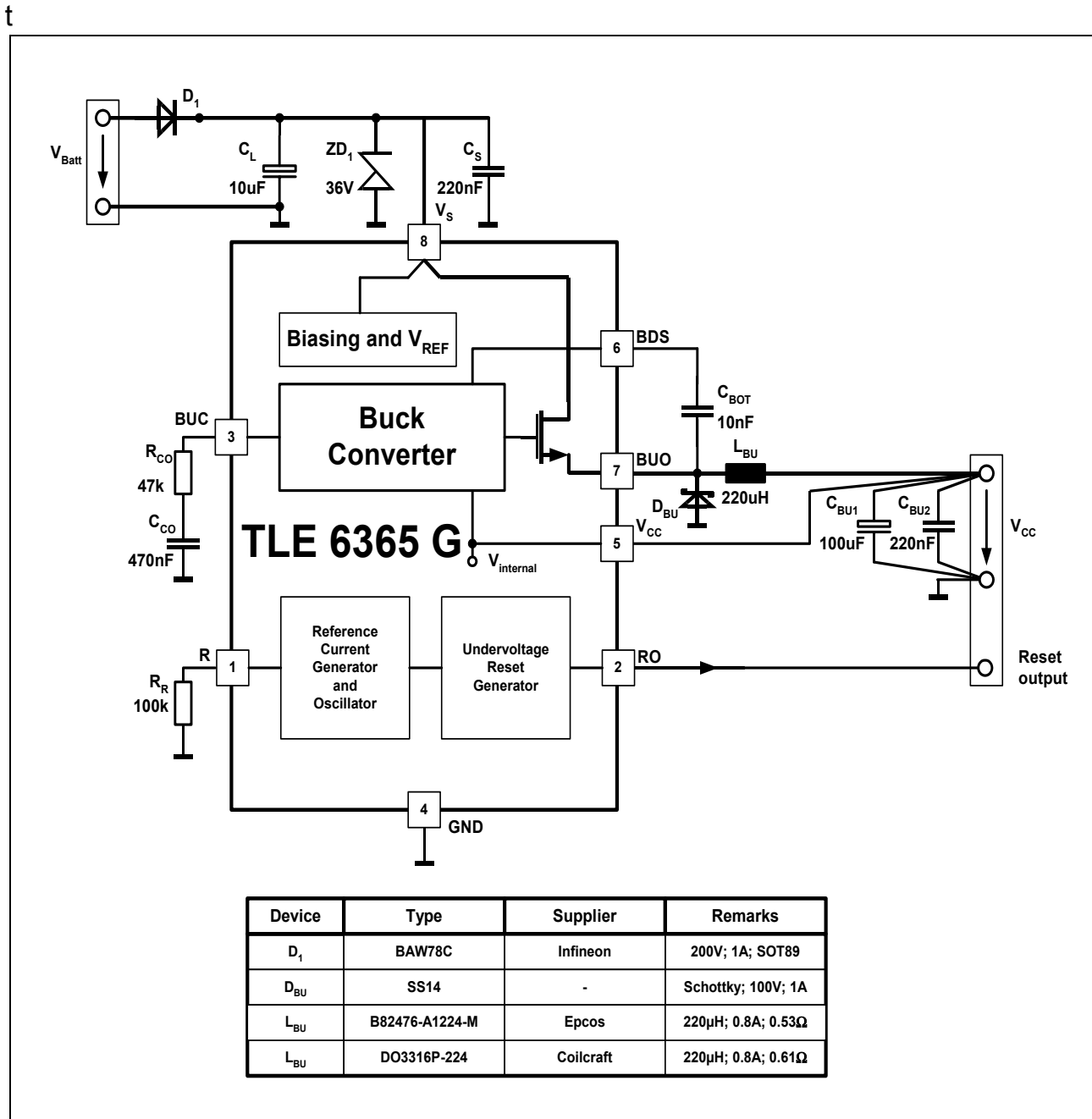
Figure 6   Application Circuit

4 Diagrams: Oscillator and Boost/Buck-Converter Performance

In the following the behaviour of the Boost/Buck-converter and the oscillator is shown.

Efficiency Buck vs. Boost Voltage
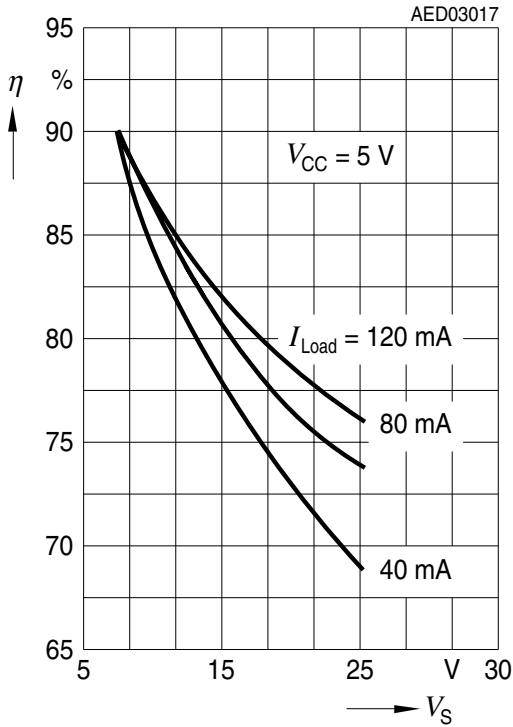
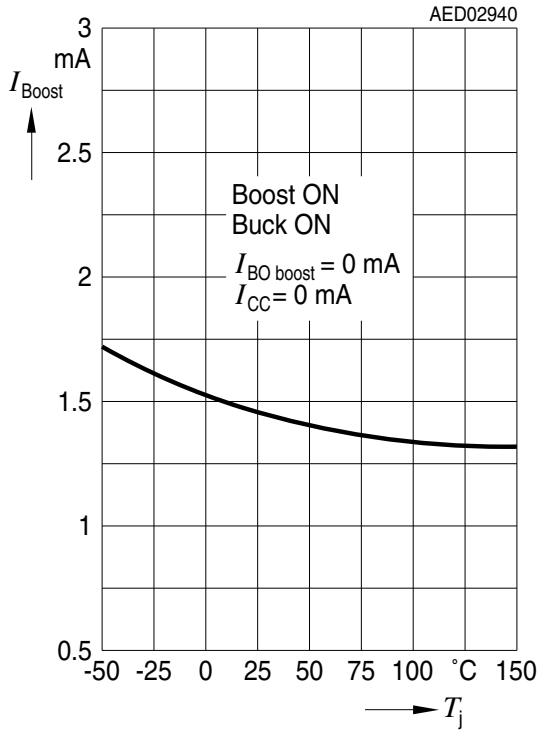**Oscillator Frequency Deviation vs. Junction Temperature**
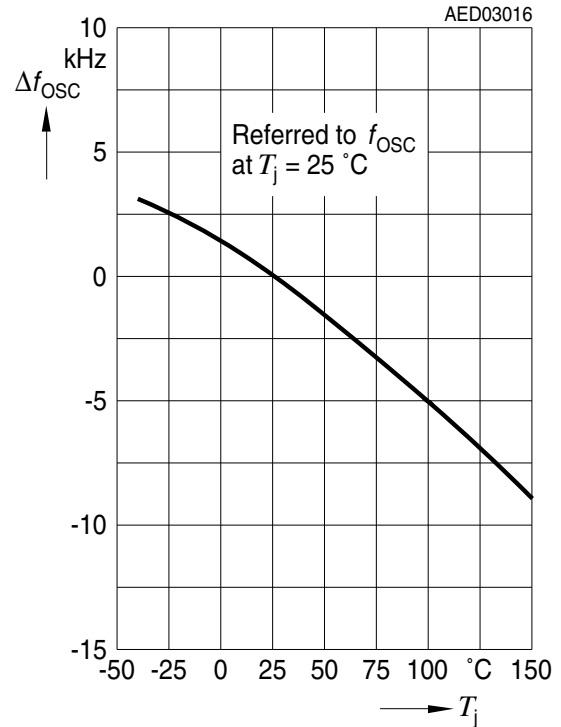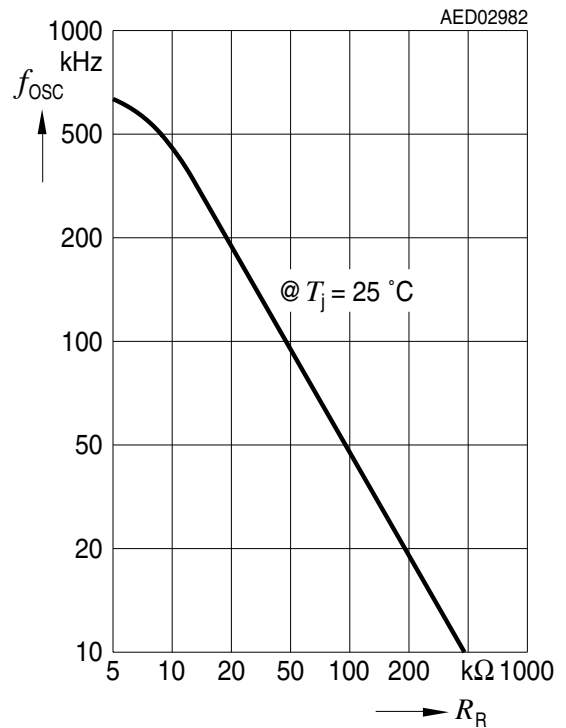

Feedback Voltage vs. Junction Temperature
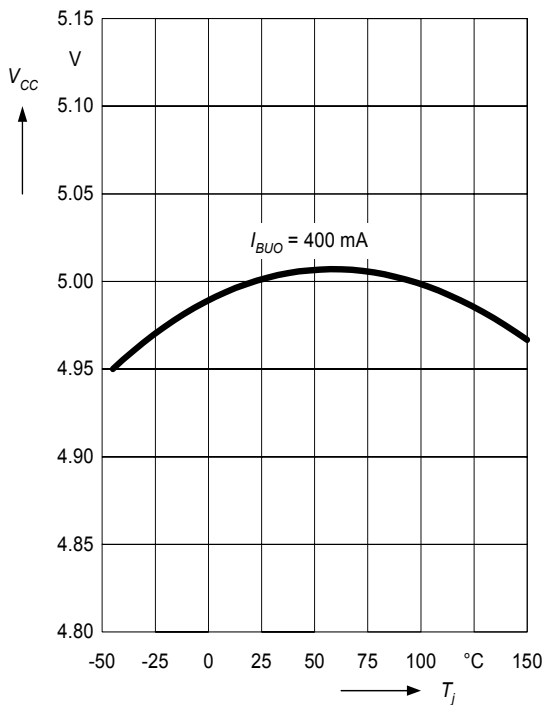
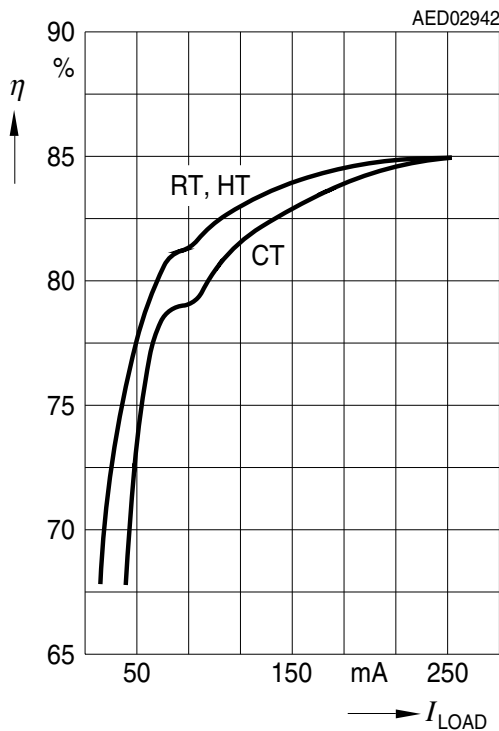**Buck Overcurrent Threshold vs. Junction Temperature**
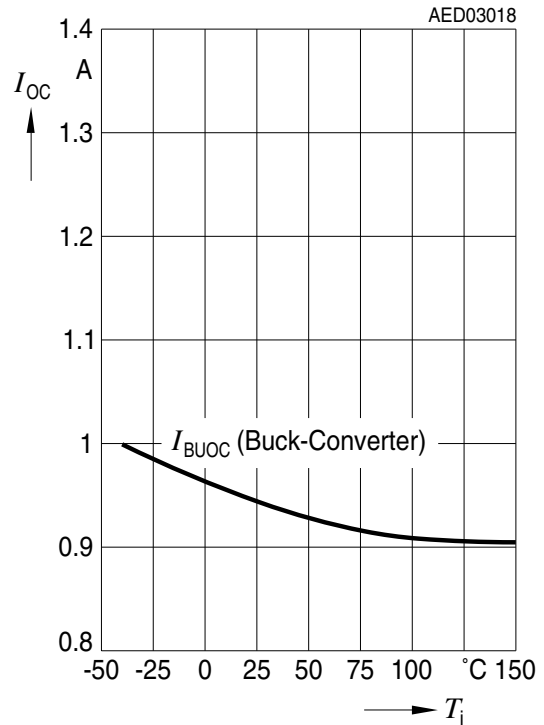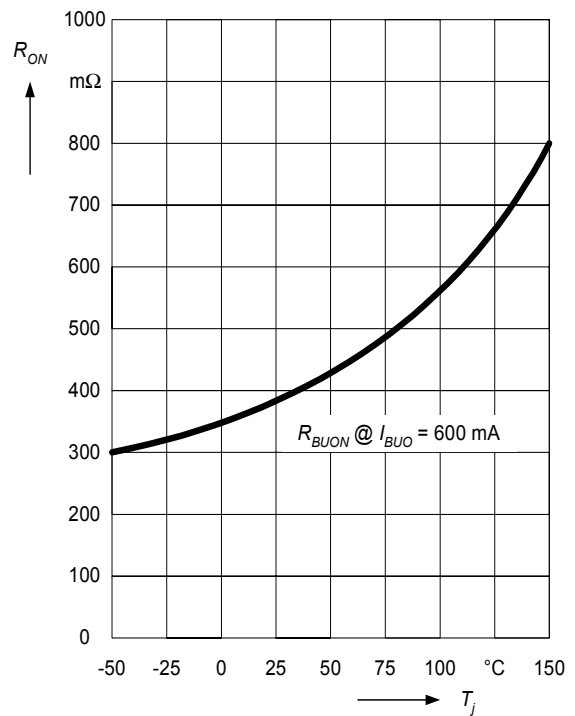
Current Consumption vs. Junction Temperature

AED02940

Boost ON
Buck ON

$I_{BO\,boost} = 0$ mA
$I_{CC} = 0$ mA

I_{Boost} (mA) vs. T_j (°C)

Oscillator Frequency vs. Resistor between R and GNDr

AED02982

@ $T_j = 25$ °C

f_{OSC} (kHz) vs. R_R (kΩ)

Efficiency Buck vs. Load

AED02942

RT, HT

CT

η (%) vs. I_{LOAD} (mA)

Buck ON Resistance vs. Junction Temperature

R_{BUON} @ $I_{BUO} = 600$ mA

R_{ON} (mΩ) vs. T_j (°C)

Data Sheet Rev. 1.7

15

5 Package Outlines

0.35x45°

4 -0.2 1)

0.19 +0.06

8° MAX.

0.2 -0.1

1.45 -0.2

1.75 MAX.

1.27

0.1

0.35 +0.15 2)

0.2 8x

0.4 +0.8

6 ± 0.2

8 5

1 4

5 -0.2 1)

Index Marking
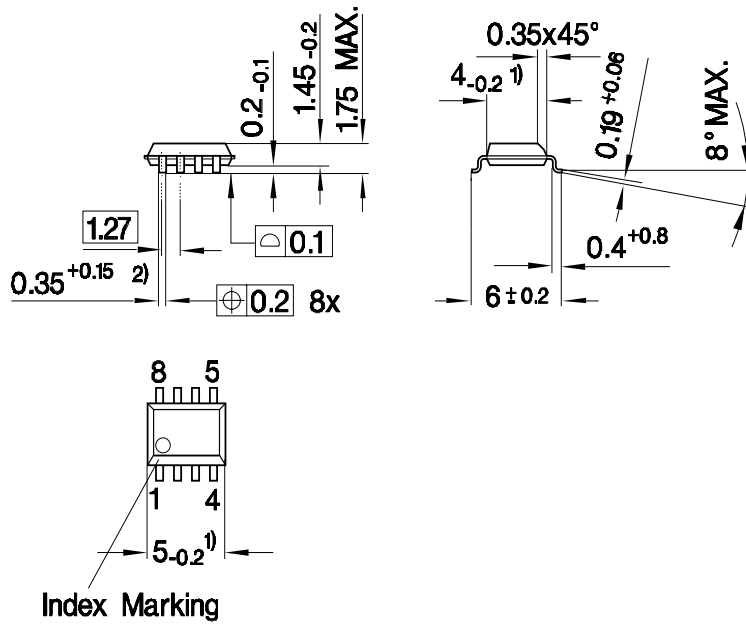
1) Does not include plastic or metal protrusion of 0.15 max. per side
2) Lead width can be 0.61 max. in dambar area

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